ERA10JEGF

SINTERED GLASS JUNCTION
FAST SWITCHING PLASTIC RECTIFIER
VOLTAGE:600 **CURRENT: 1.0A**

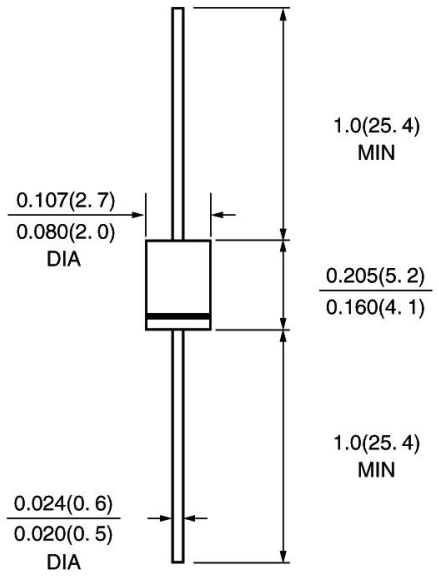
FEATURE

High temperature metallurgically bonded construction
Sintered glass cavity free junction
Capability of meeting environmental standard of MIL-S-19500
High temperature soldering guaranteed
350°C /10sec/0.375”lead length at 5 lbs tension
Operate at Ta =55°C with no thermal run away
Typical Ir<0.2μA
Low power loss, high efficient

MECHANICAL DATA

Terminal: Plated axial leads solderable per MIL-STD 202E, method 208C
Case: Molded with UL-94 Class V-0 recognized Flame Retardant Epoxy
Polarity: color band denotes cathode
Mounting position: any

A-405



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated)

	SYMBOL	ERA 10J EGF	units
Maximum Recurrent Peak Reverse Voltage	Vrrm	600	V
Maximum RMS Voltage	Vrms	420	V
Maximum DC blocking Voltage	Vdc	600	V
Maximum Average Forward Rectified Current 3/8”lead length at Ta =55°C	If(av)	1.0	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	Ifsm	30	A
Maximum Forward Voltage at Forward Current 0.5A and 25°C	Vf	1.5	V
Maximum full load reverse current full cycle average at 55°C Ambient	Ir(av)	50	μA
Maximum DC Reverse Current Ta =25°C at rated DC blocking voltage Ta =125°C	Ir	10 50	μA μA
Maximum Reverse Recovery Time (Note 1)	Trr	75	nS
Typical Junction Capacitance (Note 2)	Cj	17	pF
Typical Thermal Resistance (Note 3)	R(ja)	50	°C /W
Storage and Operating Temperature Range	Tstg, Tj	-65 to +175	°C

Note:
1. Reverse Recovery Condition If =0.5A, Ir =1.0A, Irr =0.25A
2. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
3. Thermal Resistance from Junction to Ambient at 3/8”lead length, P.C. Board Mounted

RATINGS AND CHARACTERISTIC CURVES ERA10JEGF

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FIG. 1 - MAXIMUM FORWARD CURRENT DERATING CURVE

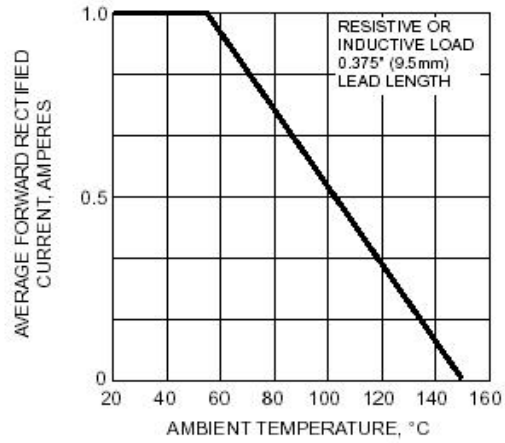

FIG. 2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

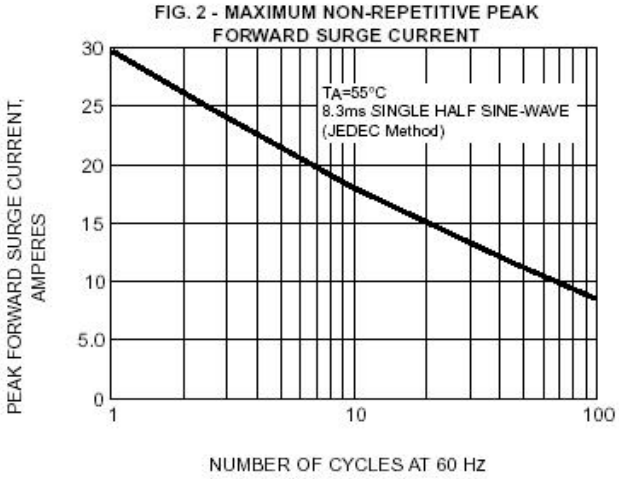

FIG. 3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

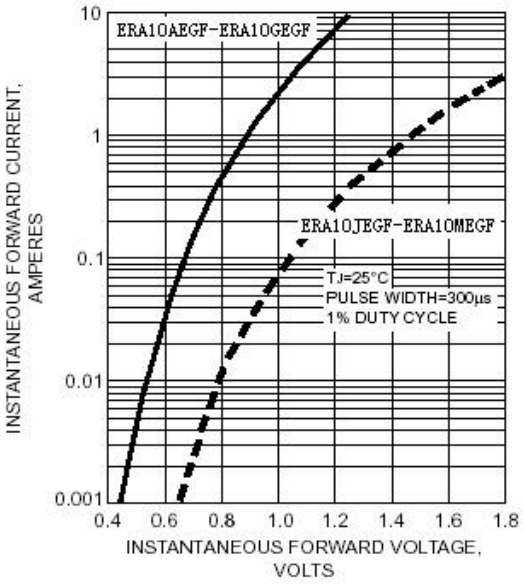

FIG. 4 - TYPICAL REVERSE LEAKAGE CHARACTERISTICS

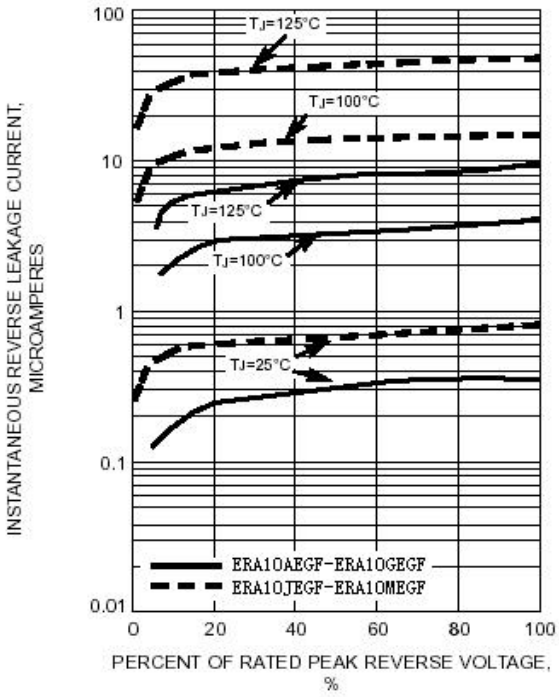

FIG. 5 - TYPICAL JUNCTION CAPACITANCE